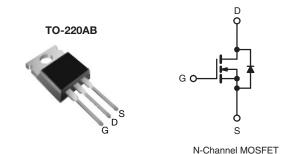


Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	200				
R _{DS(on)} (Ω)	V _{GS} = 10 V	1.5			
Q _g (Max.) (nC)	8.2				
Q _{gs} (nC)	1.8				
Q _{gd} (nC)	4.5				
Configuration	Single				



FEATURES

- · Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC





DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Load (Dh) free	IRF610PbF		
Lead (Pb)-free	SiHF610-E3		
SnPb	IRF610		
	SiHF610		

ABSOLUTE MAXIMUM RATINGS (T_C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	200	V	
Gate-Source Voltage			V_{GS}	± 20	7 v	
Continuous Drain Current	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	- I _D	3.3	А	
	V _{GS} at 10 V	T _C = 100 °C		2.1		
Pulsed Drain Current ^a			I _{DM}	10		
Linear Derating Factor				0.29	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	64	mJ	
Repetitive Avalanche Current ^a			I _{AR}	3.3	Α	
Repetitive Avalanche Energy ^a			E _{AR}	3.6	mJ	
Maximum Power Dissipation	T _C =	25 °C	P_{D}	36	W	
Peak Diode Recovery dV/dt ^c			dV/dt	5.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s		_	300 ^d	1	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
			-	1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \, ^{\circ}\text{C}$, $L = 8.8 \, \text{mH}$, $R_g = 25 \, \Omega$, $I_{AS} = 3.3 \, \text{A}$ (see fig. 12).
- c. $I_{SD} \le 3.3$ A, $dI/dt \le 70$ A/ μ s, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	3.5		

SPECIFICATIONS ($T_J = 25 ^{\circ}C$, u		100 110100,		1			
PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0$	200	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference t	to 25 °C, I _D = 1 mA	-	0.30	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	_{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	V _G	V _{GS} = ± 20 V		-	± 100	nA
Zoro Cata Valtago Drain Current	I _{DSS}	V _{DS} = 2	V _{DS} = 200 V, V _{GS} = 0 V		-	25	μΑ
Zero Gate Voltage Drain Current		V _{DS} = 160 V, V	V _{DS} = 160 V, V _{GS} = 0 V, T _J = 125 °C		-	250	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 2.0 A ^b	-	-	1.5	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 5	0 V, I _D = 2.0 A ^b	0.8	-	-	S
Dynamic							
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ f = 1.0 MHz, see fig. 5		-	140	-	pF
Output Capacitance	C _{oss}			-	53	-	
Reverse Transfer Capacitance	C _{rss}			-	15	-	
Total Gate Charge	Qg		I _D = 3.3 A, V _{DS} = 160 V, see fig. 6 and 13 ^b	-	-	8.2	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V		-	-	1.8	
Gate-Drain Charge	Q _{gd}			-	-	4.5	
Turn-On Delay Time	t _{d(on)}			-	8.2	-	
Rise Time	t _r	$V_{DD} = 100 \text{ V}, I_D = 3.3 \text{ A},$ $R_g = 24 \Omega, R_D = 30 \Omega, \text{ see fig. } 10^b$		-	17	-	- ns
Turn-Off Delay Time	t _{d(off)}			-	14	-	
Fall Time	t _f			-	8.9	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	- nH
Internal Source Inductance	L _S			-	7.5	-	
Drain-Source Body Diode Characteristic	s				·		
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	3.3	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	10	A
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S = 3.3 A, V _{GS} = 0 V ^b		-	-	2.0	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 3.3 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s}^b$		-	150	310	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.60	1.4	μC
Forward Turn-On Time	t _{on}	Intringia turn		on is dominated by L_S and L_D)			

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

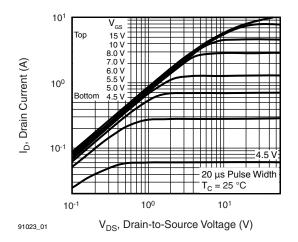


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

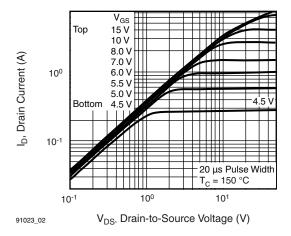


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

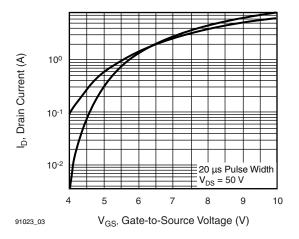


Fig. 3 - Typical Transfer Characteristics

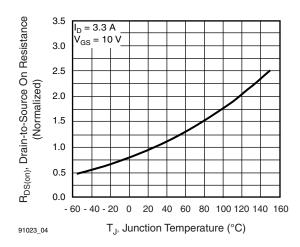


Fig. 4 - Normalized On-Resistance vs. Temperature



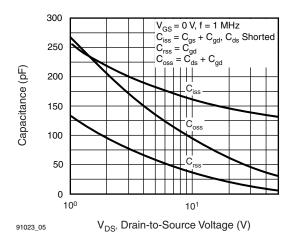


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

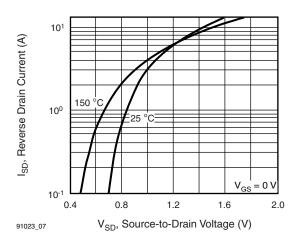


Fig. 7 - Typical Source-Drain Diode Forward Voltage

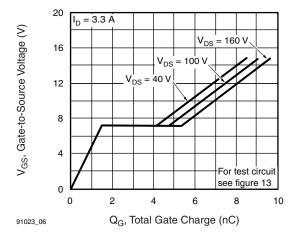


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

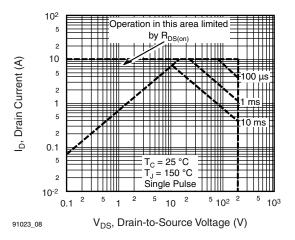
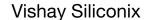


Fig. 8 - Maximum Safe Operating Area





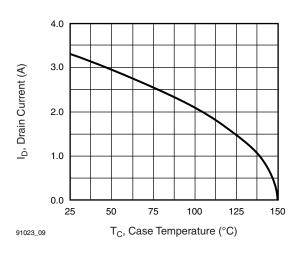


Fig. 9 - Maximum Drain Current vs. Case Temperature

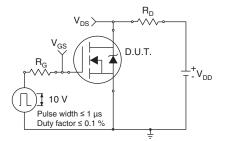


Fig. 10a - Switching Time Test Circuit

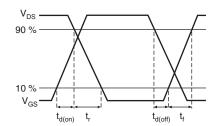


Fig. 10b - Switching Time Waveforms

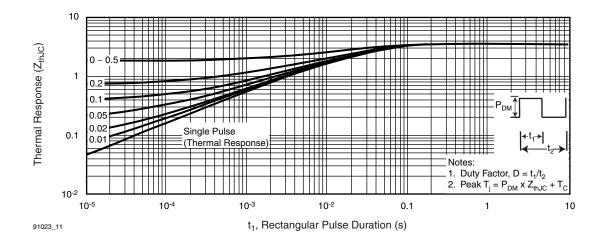


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



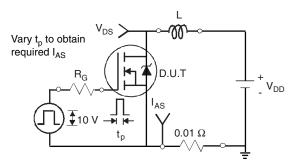


Fig. 12a - Unclamped Inductive Test Circuit

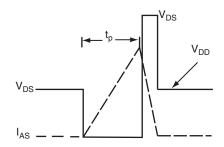


Fig. 12b - Unclamped Inductive Waveforms

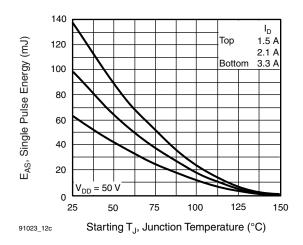


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

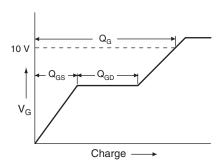


Fig. 13a - Basic Gate Charge Waveform

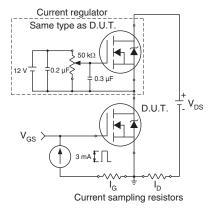
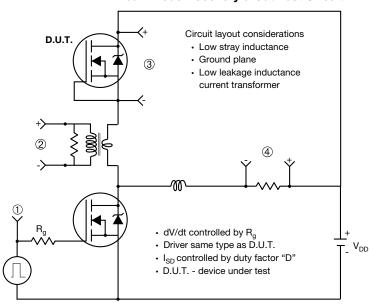


Fig. 13b - Gate Charge Test Circuit





Peak Diode Recovery dV/dt Test Circuit



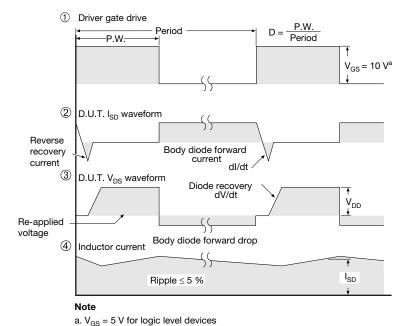


Fig. 14 - For N-Channel

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